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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

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■ Max r = 11 0mO at V = 4 5V L_ = 110 Semiconductor's proprietary PowerTrench [®] technolog			General Description
Max $r_{DS(on)} = 11.0m\Omega$ at $V_{GS} = 4.5V$, $I_D = 11A$ Semiconductor's proprietary PowerTrench® technolog deliver low $r_{DS(on)}$ and optimized BV _{DSS} capability to superior performance benefit in the application. RoHS Compliant Image: Complex technology of the application	Max r _{DS(on)}		
Applications = Inverter = Power Supplies G G G G G G G G G G G G G G G G G G G	Fast Switch	= 11.0m Ω at V _{GS} = 4.5V, I _D = 11A ing	This N-Channel MOSFET has been produced using Fairch Semiconductor's proprietary PowerTrench [®] technology deliver low $r_{DS(on)}$ and optimized BV _{DSS} capability to or superior performance benefit in the application.
 Inverter Power Supplies 			Applications
■ Power Supplies			
(TO-252) S WOSFET Maximum Ratings $T_c = 25^{\circ}C$ unless otherwise noted		G	G
Symbol Parameter Ratings L	MOSFET	(TO-252)	unless otherwise noted
V _{DS} Drain to Source Voltage 40		(TO-252) Maximum Ratings T _C = 25°C u	
V _{GS} Gate to Source Voltage ±20	Symbol	(TO-252) • Maximum Ratings T _C = 25°C un Param	meter Ratings Uni
Drain Current -Continuous (Package limited) T _C = 25°C 50	Symbol V _{DS}	(TO-252) Maximum Ratings T _C = 25°C un Param Drain to Source Voltage Gate to Source Voltage	Ratings Unit 40 V ±20 V
	Symbol V _{DS}	(TO-252) Maximum Ratings T _C = 25°C un Param Drain to Source Voltage Gate to Source Voltage Drain Current -Continuous (Package In	Ratings Unit 40 V ±20 V limited) T _C = 25°C 50
T = 05% (Nate 4a)	Symbol V _{DS} V _{GS}	(TO-252) Maximum Ratings T _C = 25°C un Drain to Source Voltage Gate to Source Voltage Drain Current -Continuous (Package li -Continuous (Silicon lim	Ratings Unit 40 V ± 20 V limited) T _C = 25°C 50 nited) T _C = 25°C 57
$\frac{100}{-\text{Continuous}}$		(TO-252) Maximum Ratings T _C = 25°C un Drain to Source Voltage Gate to Source Voltage Drain Current -Continuous (Package li -Continuous (Silicon lim -Continuous	Ratings Unit 40 V ± 20 V imited) T _C = 25°C 50 nited) T _C = 25°C 57 T _A = 25°C (Note 1a) 15.2

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	2.8	
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note 1a)	40	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Note 1b)	96	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD8447L	FDD8447L	D-PAK(TO-252)	13"	16mm	2500 units

mJ

W

°C

153

44

3.1

1.3

FDD8447L 40V N-Channel PowerTrench[®] MOSFET

FDD8447L 4
20
N-Channel
PowerTrench [®]
MOSFET

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics					1	
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	40			V	
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$, referenced to 25°C		35		mV/°C	
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 32V, V_{GS} = 0V$			1	μA	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V, V_{GS} = 0V$			±100	nA	
On Chara	cteristics (Note 2)						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	1.0	1.9	3.0	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \mu A$, referenced to 25°C		-5		mV/°C	
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10V, I _D = 14A		7.0	8.5		
		V _{GS} = 4.5V, I _D = 11A	5V, I _D = 11A 8.5		11.0	mΩ	
		V _{GS} = 10V, I _D = 14A, T _J =125°C		10.4	14.0		
9 _{FS}	Forward Transconductance	V _{DS} = 5V, I _D = 14A		58		S	
Dynamic	Characteristics						
C _{iss}	Input Capacitance			1970		pF	
C _{oss}	Output Capacitance	─ V _{DS} = 20V, V _{GS} = 0V, f = 1MHz		250		pF	
C _{rss}	Reverse Transfer Capacitance			150		pF	
R _g	Gate Resistance	f = 1MHz		1.27		Ω	
Switching	Characteristics						
t _{d(on)}	Turn-On Delay Time			12	21	ns	
t _r	Rise Time	$V_{\text{DD}} = 20V, I_{\text{D}} = 1A$ $V_{\text{GS}} = 10V, R_{\text{GEN}} = 6\Omega$		12	21	ns	
t _{d(off)}	Turn-Off Delay Time			38	61	ns	
t _f	Fall Time			9	18	ns	
Q _{g(TOT)}	Total Gate Charge, V _{GS} = 10V			37	52	nC	
Q _{g(TOT)}	Total Gate Charge, V _{GS} = 5V	V _{DD} = 20V, I _D = 14A V _{GS} = 10V		20	28	nC	
Q _{qs}	Gate to Source Gate Charge			6		nC	
Q _{gd}	Gate to Drain "Miller" Charge			7		nC	
Drain-Sou	Irce Diode Characteristics						
I _S	Maximum Continuous Drain-Source Diode	Forward Current (Note 1a)			2.6	А	
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_S = 14A$ (Note 2)		0.8	1.2	V	
t _{rr}	Reverse Recovery Time			22		ns	
Q _{rr}	Reverse Recovery Charge	I _F = 14A, di/dt = 100A/μs		11		nC	

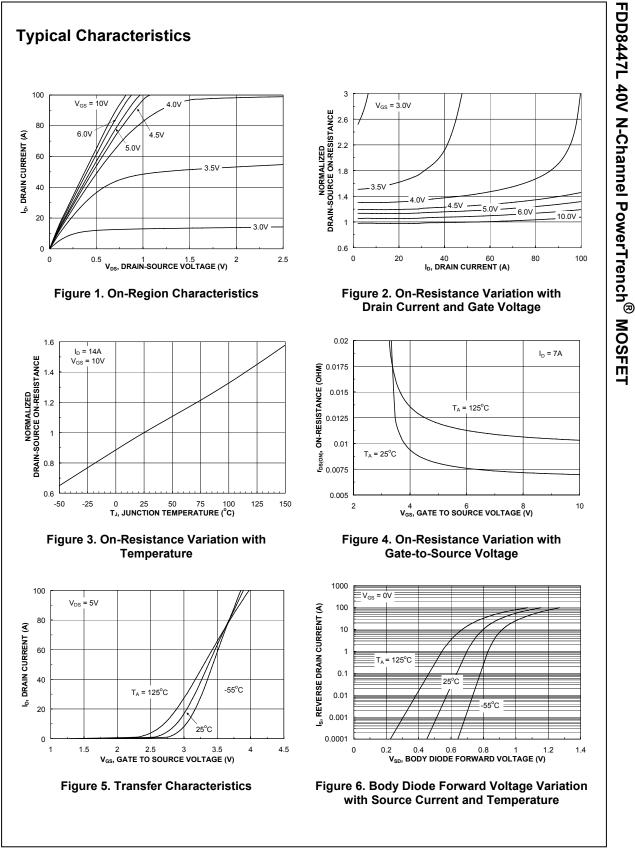
I: R_{0JA} is the sum of the junction-to-case and case-to- ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design while R_{0JA} is determined by the user's board design.

a. 40°C/W when mounted on a 1 in2 pad of 2 oz copper

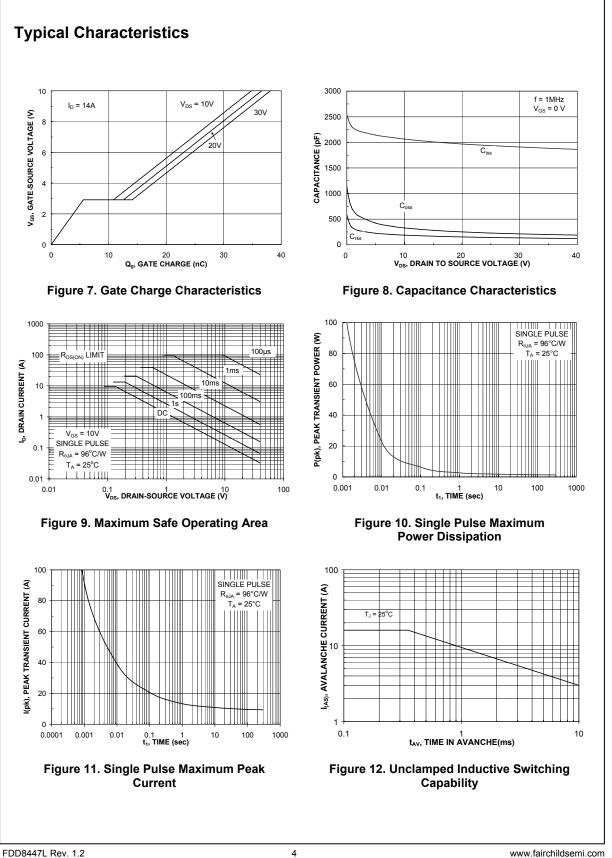
b. 96°C/W when mounted on a minimum pad.

2: Pulse Test: Pulse Width < 300μ s, Duty cycle < 2.0%.

3: Starting TJ = 25⁰C, L = 1mH, IAS = 17.5A, VDD = 40V, VGS = 10V.

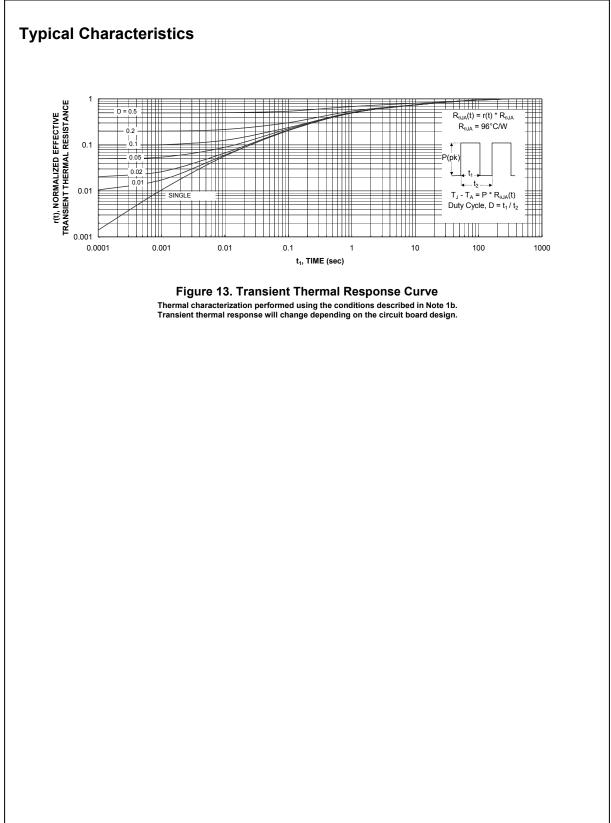


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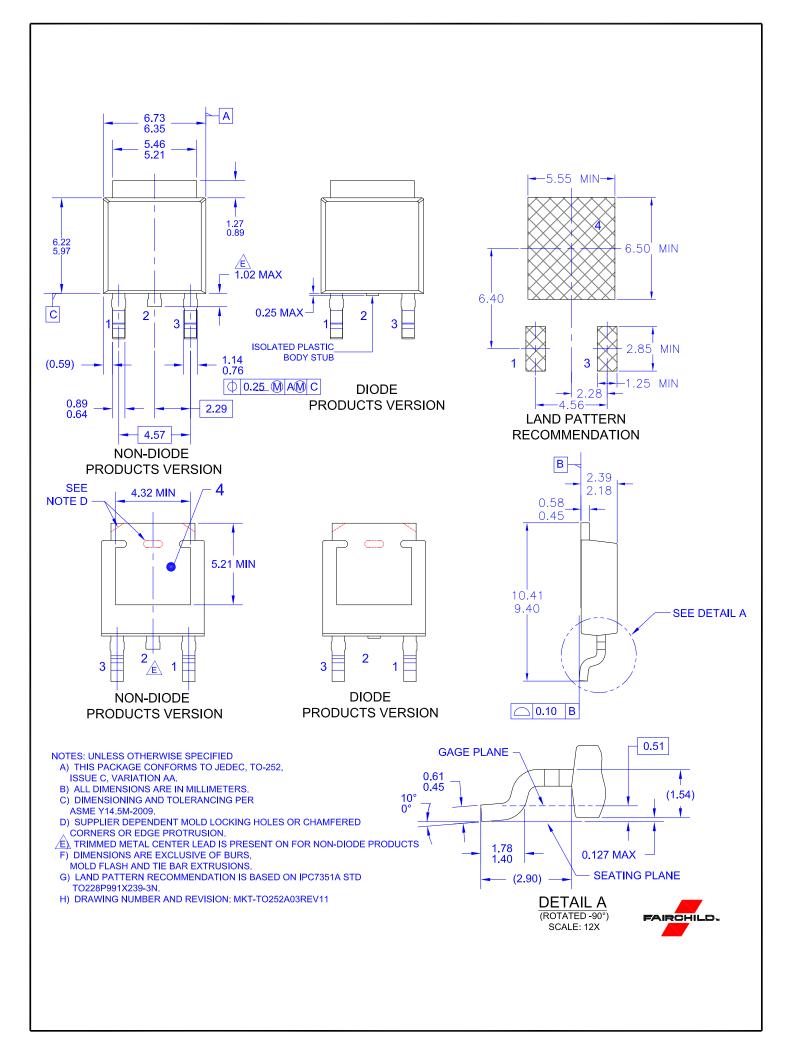
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FDD8447L 40V N-Channel PowerTrench[®] MOSFET

FDD8447L Rev. 1.2



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